

**REMARKS**

Claims 1-10 are pending. Applicant respectfully submits no new material is presented herein.

**Allowed/Allowable Claims**

Applicant respectfully acknowledges and appreciates the indication by the Examiner that Claims 8-10 are allowed and that Claims 2-4, although objected to for being dependent upon a rejected base claim, would be in condition for allowance if rewritten in independent form, including all of the features of the base claim and any intervening claims.

**Claims Rejected—35 U.S.C. § 102**

Claims 1 and 5-7 are rejected under 35 U.S.C. § 102(e) as being anticipated by Applicant Admitted Prior Art ("AAPA") (Figures 1A and 1B). Applicant respectfully traverses the rejection.

Claim 1 recites an interconnection structure of conductive wirings for interconnecting a pair of interconnection objects by a thermocompression bonding, in which the conductive wirings are disposed on the interconnection objects, respectively, including interconnection portions formed of conductive wiring patterns on a surface of each supporting body of the interconnection objects, the interconnection portions being provided with gaps between adjacent ones; an anisotropic conductive film containing conductive particles therein, the film being interposed between the interconnection portions disposed on the respective interconnection objects; and an accumulating space formed in the respective gaps between the conductive wiring patterns in order to prevent an over-density of the conductive particles flown out from the interconnection portions to the gaps due to the thermocompression bonding from occurring.

However, contrary to the Office Action's assertion, the AAPA does not disclose or suggest each and every feature recited in Claim 1. Particularly, Figures 1A and 1B do **not** disclose an accumulating space formed in the respective gaps between the conductive wiring patterns in order to prevent an over-density of the conductive particles flown out from the interconnection portions to the gaps due to the thermocompression bonding from occurring, as recited in Claim 1. Figures 1A and 1B simply do **not** disclose or suggest any accumulating space formed in the gaps between the conductive wiring patterns. Although the AAPA includes gaps (146) formed between conductive wiring patterns, the AAPA does not disclose or suggest an accumulating space formed in the gaps (146). As a result, the density of conductive particles (142) becomes over-dense in the gaps (146) due to thermocompression bonding, which forces the conductive particles (142) out from interconnecting portions and into the gaps (146). Moreover, the Office Action does **not** cite to any portion of Figures 1A and 1B purporting to disclose or suggest an accumulating space formed in respective gaps between conductive wiring patterns. On page 3, lines 4-7, the Office Action merely makes an unsupported, conclusory statement that Figures 1A and 1B disclose such a feature.

According to M.P.E.P. § 2131, a claim is anticipated only if each and every element as set forth in the claim is found, either expressly or inherently described, in a single prior art reference. Therefore, because Figures 1A and 1B do **not** disclose or suggest an accumulating space formed in respective gaps between conductive wiring patterns, as recited in Claim 1, Applicant respectfully submits that the Office Action has failed to establish *prima facie* anticipation. Accordingly, Applicant respectfully submits

Claims 2-7 depend directly or indirectly from Claim 1 and, thus, incorporate each and every feature recited therein. As such, Applicant respectfully submits that Claims 2-7 should be deemed allowable for the same reasons Claim 1 is allowable, as well as for the additional subject matter recited therein.

Accordingly, Applicant respectfully requests withdrawal of the rejection.

**Conclusion**

In view of the foregoing, reconsideration of the application, withdrawal of the outstanding rejection, allowance of Claims 1-10, and the prompt issuance of a Notice of Allowability are respectfully solicited.

Should the Examiner believe anything further is desirable in order to place this application in better condition for allowance, the Examiner is requested to contact the undersigned at the telephone number listed below.

In the event this paper is not considered to be timely filed, Applicant respectfully petitions for an appropriate extension of time. Any fees for such an extension, together with any additional fees that may be due with respect to this paper, may be charged to counsel's Deposit Account No. 01-2300, **referencing docket number 107156-00215.**

Respectfully submitted,  
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